STW23N85K5



N-channel 850 V, 0.2 Ω typ., 19 A MDmesh™ K5 Power MOSFET in a TO-247 package

Datasheet - production data

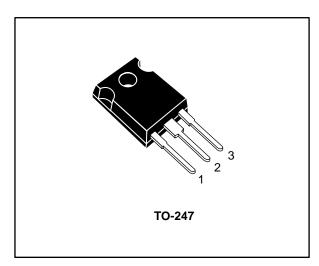
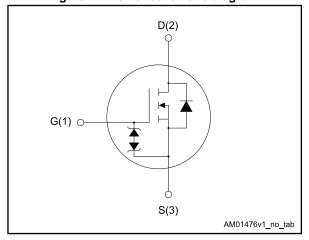


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	I _D	Ртот
STW23N85K5	850 V	0.275 Ω	19 A	250 W

- Industry's lowest R_{DS(on)} x area
- Industry's best figure of merit (FoM)
- Ultra low gate charge
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing
STW23N85K5	23N85K5	TO-247	Tube

Contents STW23N85K5

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STW23N85K5 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit	
V _{GS}	Gate-source voltage	±30	V	
	Drain current (continuous) at T _{case} = 25 °C	19	^	
I _D	Drain current (continuous) at T _{case} = 100 °C	12.4	А	
I _{DM} ⁽¹⁾	Drain current (pulsed)	250	А	
P _{TOT}	Total dissipation at T _{case} = 25 °C	250	W	
dv/dt ⁽²⁾	Peak diode recovery voltage slope	6	V/ns	
T _{stg}	Storage temperature		٥,0	
T _j	Operating junction temperature	-55 to 150 °C		

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	0.5	۰۵۸۸
R _{thj-amb}	Thermal resistance junction-ambient 45		°C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR} ⁽¹⁾	Avalanche current, repetitive or not repetitive	6	Α
E _{AS} ⁽²⁾	Single pulse avalanche energy	200	mJ

Notes:

 $^{^{\}left(1\right) }$ Pulse width is limited by safe operating area.

 $^{^{(2)}}$ $I_{SD} \leq$ 19 A, di/dt=100 A/µs; V_{DS} peak < $V_{(BR)DSS},$ V_{DD} = 80% $V_{(BR)DSS}.$

 $^{^{(1)}}$ Pulse width limited by T_{jmax} .

 $^{^{(2)}}$ starting T_{j} = 25 °C, I_{D} = $I_{AR},\,V_{DD}$ = 50 V.

Electrical characteristics STW23N85K5

2 Electrical characteristics

(T_{case} = 25 °C unless otherwise specified)

Table 5: Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	850			٧
7	Zoro goto voltago	$V_{GS} = 0 \text{ V}, V_{DS} = 850 \text{ V}$			10	
I _{DSS}	I _{DSS} Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 850 \text{ V},$ $T_{case} = 125 \text{ °C}$			50	μΑ
I _{GSS}	Gate-body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±10	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 100 \mu A$	3	4	5	>
R _{DS(on)}	Static drain-source on-resistance	V _{GS} = 10 V, I _D = 9.5 A		0.2	0.275	Ω

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		ı	1650	ı	
C _{oss}	Output capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$	ı	115	ı	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0 V$	ı	2	ı	ρı
Coss eq. (1)	Equivalent output capacitance	$V_{DS} = 0$ to 680 V, $V_{GS} = 0$ V	-	185	-	pF
R _G	Intrinsic gate resistance	$f = 1 \text{ MHz}, I_D = 0 \text{ A}$	1	3.5	ı	Ω
Q_g	Total gate charge	$V_{DD} = 520 \text{ V}, I_D = 60 \text{ A},$	ı	38	ı	
Q_{gs}	Gate-source charge	V _{GS} = 10 V (see <i>Figure 17:</i>	ı	11		nC
Q_gd	Gate-drain charge	"Gate charge test circuit")	ı	20	ı	

Notes:

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 400 \text{ V}, I_D = 9.5 \text{ A}$	-	22		
t _r	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 16: "Switching times	-	14	-	
t _{d(off)}	Turn-off delay time	test circuit for resistive load"	-	55	-	ns
t _f	Fall time	and Figure 21: "Switching time waveform")	-	8	-	

 $^{^{(1)}}$ $C_{oss\ eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS} .

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		ı		19	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		76	Α
V _{SD} ⁽²⁾	Forward on voltage	V _{GS} = 0 V, I _{SD} = 19 A	-		1.5	V
t _{rr}	Reverse recovery time	I _{SD} = 19 A, di/dt = 100 A/μs,	1	510		ns
Q _{rr}	Reverse recovery charge	V _{DD} = 60 V (see Figure 18: "Test circuit for inductive load	-	11		μC
I _{RRM}	Reverse recovery current	switching and diode recovery times")	-	43		Α
t _{rr}	Reverse recovery time	I _{SD} = 19 A, di/dt = 100 A/µs,	-	684		ns
Q _{rr}	Reverse recovery charge	V_{DD} = 60 V, T_j = 150 °C (see Figure 18: "Test circuit for	-	14		μC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	-	41		Α

Notes:

⁽¹⁾ Pulse width is limited by safe operating area.

 $^{^{(2)}}$ Pulse test: pulse duration = 300 $\mu s,$ duty cycle 1.5%.

2.1 Electrical characteristics (curves)

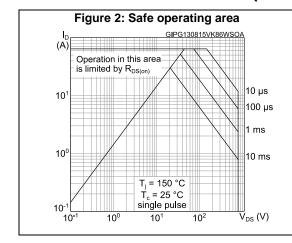
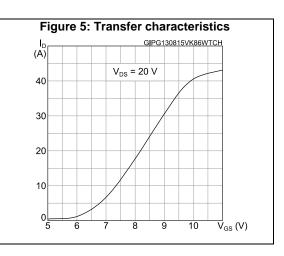
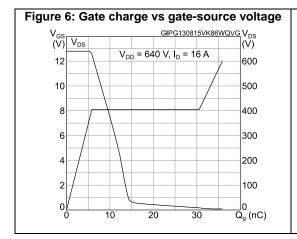
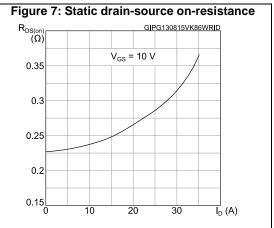


Figure 3: Thermal impedance K
GC20530 $\delta = 0.5$ $\delta = 0.2$ $\delta = 0.1$ $\delta = 0.05$ $\delta = 0.05$ $\delta = 0.01$ Single pulse $\delta = 0.01$ $\delta = 0.01$ $\delta = 0.01$ $\delta = 0.01$

Figure 4: Output characteristics GIPG130815VK86WOCH I_D (A) 40 $V_{GS} = 10 \text{ V}$ $V_{GS} = 9 V$ 30 $V_{GS} = 8 \text{ V}$ 20 $V_{GS} = 7 V$ 10 $V_{GS} = 6 V$ $V_{GS} = 5 V$ 12 16 $\overrightarrow{V}_{DS}(V)$







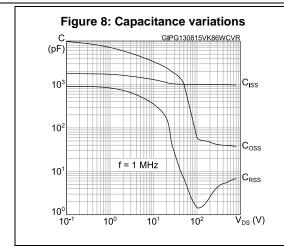
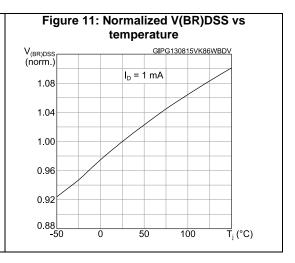
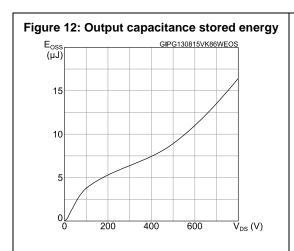


Figure 10: Normalized on-resistance vs temperature

R_{DS(on)} GIPG130815VK86WRON
(norm.)
2.6
2.2
1.8
1.4
1.0
0.6
0.2
-50
0
50
100
T_j (°C)





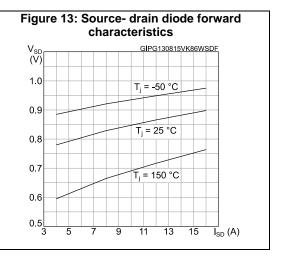
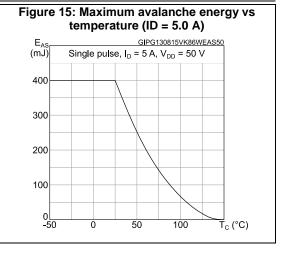


Figure 14: Maximum avalanche energy vs temperature (ID = 3.5 A)

E_{AS}
(mJ)
Single pulse, I_D = 3.5 A, V_{DD} = 50 V

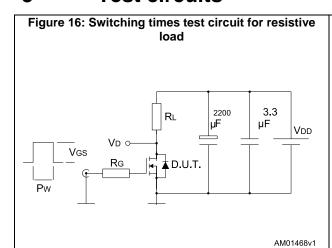
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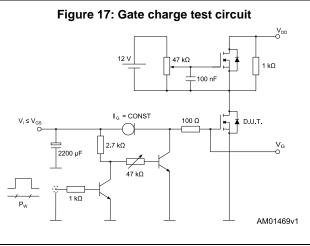
٦, (°C)

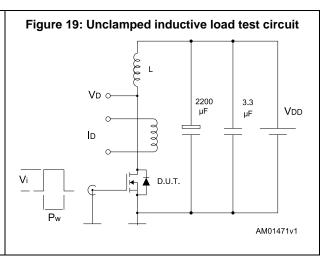


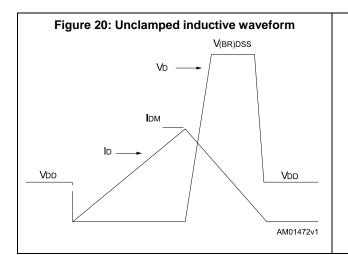
STW23N85K5 Test circuits

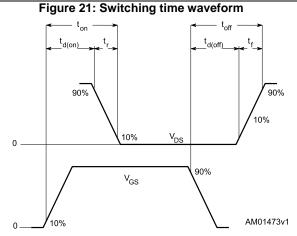
3 Test circuits











4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 TO-247 package information

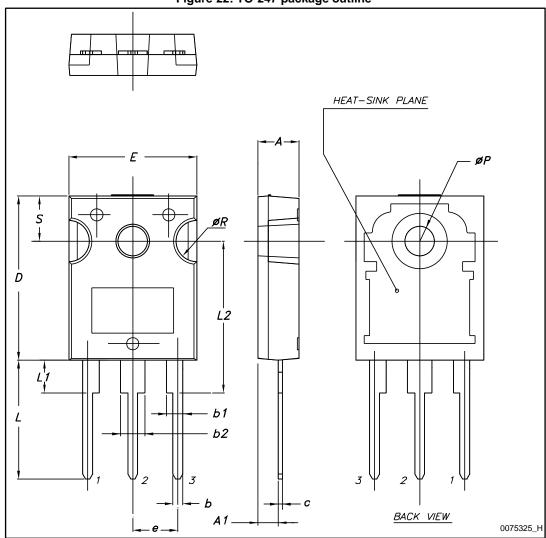


Figure 22: TO-247 package outline

Table 9: TO-247 package mechanical data

Dim		mm.	
Dim.	Min.	Тур.	Max.
А	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
E	15.45		15.75
е	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

Revision history STW23N85K5

5 Revision history

Table 10: Document revision history

Date	Revision	Changes
06-Aug-2012	1	First release.
21-Jan-2014	2	Document status promoted from preliminary to production data. Added Figure 12: Maximum avalanche energy vs temperature.
13-Aug-2015	3	Text and formatting changes throughout document. On cover page: - updated Title, Features and Description Updated Section Electrical characteristics Updated Section Electrical characteristics (curves) Updated and renamed Section Package information (was Package mechanical data)

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